ADVANCE INTO ALL-ELECTRIC WITH ecoStitch

All electric hot melt dispensing systems have been the driving force behind the reshaping of the packaging industry. Join some of the world’s leading packagers already benefiting from EcoStitch™ and let the experts at Valco Melton take your production line to an unparalleled level of efficiency.

ecoStitch BENEFITS

1. More uptime. Improve the efficiency of your packaging process by increasing your production uptime.
2. No plugging. Eliminate nozzle plugging by working at lower pressures with larger nozzle orifices and glue filtration in the gun body.
3. Reduce adhesive consumption from 35 to 50%. Elimination of compressed air removes moving parts, dynamic seals and frequent parts changes.
4. No consumable parts. Economic savings that guarantee payback in as little as 4 months.

With over 2 billion cycle capability and fewer moving parts virtually eliminating the chances of failure, the spare parts stock is reduced to a minimum, resulting in lower investment, storage costs and downtime associated with the replacement of parts. In addition, the reduction in adhesive usage brings additional savings that guarantee payback in as little as 4 months.

VD2 DRIVERS

The VD2 drivers integrate into any existing machine and provide the EcoStitch dot and gap control to regulate adhesive usage. Each valve can be individually programmed for a specific dot size and gap offering unparalleled flexibility to achieve maximum adhesive savings while achieving best bond quality.
Valco Melton has developed a unique version of our hot melt systems to help manufacturers deliver the best product. The EC Pro Series and Kube Pro are designed to integrate all digital characteristics of the heating, on/off, I/O’s, pump engage, pump speeds, pump pressure and other various alarm and melter setpoints into your parent machine HMI.

**KUBE SYSTEM**

**MELT ON DEMAND MELTERS**

Designed to allow customers to use the same unit for all their packaging needs, the Kube helps improve system operation by removing degradation problems, as well as minimizes the maintenance and downtime associated with gluing systems.

**Melt on demand.** Promote adhesive stability and reduce char by only melting adhesive as you need it.

**Mount anywhere.** Engineered to operate with three different install configurations, the Kube is suitable for both new machine installations, as well as system upgrades/replacements.

**Simple conversion.** Fully compatible with other industry standard equipment, the Kube retrofits your packaging line without additional investment in hoses, guns or spare parts.

**Operator free.** Enclosed system with integrated auto feed keeps out dirt and debris, and promotes a safer work environment. Also includes manual fill option.

**Zero maintenance.** Strategically designed to automatically feed adhesive, contaminants are left out, eliminating any chance of plugged nozzles.

**INDUSTRY STANDARDS**

**HOT MELT SYSTEMS**

Ever since first launched by Valco Melton, the Evolution C Series has become the new and indisputable standard in hot melt dispensing equipment for the packaging industry.

**Ease of use.** Quick and easy configuration to adapt to any production line.

**Safer operation.** Engineered to minimize safety hazards related with high working temperatures and pressure.

**Universal installation.** Compact design with common footprint and market standard connections, designed for easy installation in any new or existing packaging line.

**Top performance.** EC series reset the standard in hot melt dispensing systems by implementing in its configuration top level features. Optional upgrades include a fully integrated hot melt feeding system for completely automated adhesive dispensing.

**More than a Melt Unit**

**PRO SERIES**

Valco Melton has developed a unique version of our hot melt systems to help manufacturers deliver the best product. The EC Pro Series and Kube Pro are designed to integrate all digital characteristics of the heating, on/off, I/O’s, pump engage, pump speeds, pump pressure and other various alarm and melter setpoints into your parent machine HMI.

**Ethernet Communication to the parent machine**

**Communicate with other devices via WIFI**

**User friendly touch screen**

**Adhesive consumption measurement**

**Reports of consumption, adhesive usage, number of boxes, etc.**

**Close-loop**

**A Flow Control upgrade is also available for a more accurate adhesive measurement when placed close to each applicator.**
HOT MELT INSPECTION

PackChek™ can be installed at the discharge of your machine, without space constraints.

Tolerance levels allow every pattern to be designated as ‘good’, ‘marginal’, or ‘bad’. Marginal products can set off a warning, alerting operators to adjust the glue pattern or fix an issue in real time, without shutting down the machine.

The PackChek System is the latest innovation in hot melt inspection for end-of-line packaging. Utilizing both thermal and visual imaging, PackChek inspects the heat signature of the package to ensure hot melt glue has been applied to the correct locations.

How are defects defined by the system?

Defects are defined by predetermined tolerance levels and “glue windows,” which are configured by the user. Settings for tolerance levels include:

- Missing glue beads
- Weak glue beads
- Crushed, torn or open flaps
- Misaligned glue beads

PackChek™ can be programmed for any number of cases and any number of glue patterns. Multi-packers that convert to various size / count packs may require the camera to be moved in or out, if mounted on the discharge conveyor.

For the most advanced precision gluing experience, a complete line of pattern controls are available as both an external accessory to the packaging line or as an integrated feature of the EC Series Unit.